

## WHAT IS CLAIMED IS:

1                   1.     A method for forming an electroluminescent lamp that  
2 includes an electroluminescent active layer, the method comprising:

3                   a)     applying a first conductive layer to a substrate wherein the  
4 first conductive layer is an opaque conductive layer or a transparent conductive  
5 layer;

6                   b)     applying a light-producing layer to the first conductive layer  
7 wherein the light-producing layer is:

8                   1.     an electroluminescent active layer;

9                   2.     a multilayer construction comprising a dielectric layer  
10 and an electroluminescent active layer wherein the  
11 dielectric layer is applied to the first conductive layer  
12 before the electroluminescent active layer is applied;  
13 or

14                  3.     a multilayer construction comprising a dielectric layer  
15 and an electroluminescent active layer wherein the  
16 electroluminescent active layer is applied to the first  
17 conductive layer before the dielectric layer is applied;  
18 and

19                  c)     applying a second conductive layer to the light-producing  
20 layer wherein the second conductive layer is an opaque conductive layer or a  
21 transparent conductive layer;

22                  with the proviso that the first conductive layer and the second  
23 conductive layer are not both opaque conductive layers and wherein the  
24 electroluminescent layer is made by a method comprising:

25                  1)     applying an electroluminescent composition wherein  
26 the electroluminescent composition has the  
27 characteristic of being curable into the  
28 electroluminescent active layer when irradiated with

29 UV light and does not contain any significant amount  
 30 of volatile organic solvents that do not become  
 31 incorporated in the electroluminescent active layer  
 32 after curing; and

33 2) curing the electroluminescent composition with UV  
 34 light for a sufficient time to form the  
 35 electroluminescent active layer.

36 wherein the electroluminescent composition does not contain any  
 37 significant amount of volatile organic solvents that do not become incorporated in  
 38 the electroluminescent layer after the electroluminescent composition is cured.

1 2. The method of claim 1, wherein the electroluminescent  
 2 composition comprises:

3 at least one oligomer selected from the group consisting of an  
 4 acrylated urethane oligomer, an acrylic oligomer, an epoxy oligomer, a polyester  
 5 oligomer, and mixture thereof;

6 an acrylate monomer;

7 a photoinitiator; and

8 a phosphor.

1 3. The method of claim 2, wherein the acrylated monomer is an  
 2 isobornyl acrylate.

1 4. The method of claim 3, wherein:

2 the at least one oligomer is present in an amount of about 10% to  
 3 40% of the weight of the electroluminescent composition;

4 the acrylate monomer is present in an amount of about 4% to 30%  
 5 of the weight of the electroluminescent composition;

6 the photoinitiator is present in an amount of about 0.5% to 6% of the  
 7 weight of the electroluminescent composition; and

8 the phosphor is present in an amount of about 28% to 80% of the  
9 weight of the electroluminescent composition;

1 5. The method of claim 3, wherein the at least one aliphatic  
2 acrylated oligomer is at least one urethane oligomer.

1 6. The method of claim 4, wherein the electroluminescent  
2 composition further comprises:

3 an adhesion promoter in an amount of about 1% to 10% of the  
4 weight of the composition; and

5 a flow promoting agent in an amount of 0.1 % to 5% of the weight  
6 of the electroluminescent composition.

1 7. The method of claim 6, wherein:

2 the at least one oligomer is present in an amount of about 34 % of  
3 the weight of the electroluminescent composition;

4 the acrylate monomer is present in an amount of about 20% of the  
5 weight of the electroluminescent composition;

6 the photoinitiator is present in an amount of about 3% of the weight  
7 of the electroluminescent composition; and

8 the phosphor is present in an amount of about 33% of the weight of  
9 the electroluminescent composition;

10 an adhesion promoter in an amount of about 7% of the weight of the  
11 composition; and

12 a flow promoting agent in an amount of 3% of the weight of the  
13 electroluminescent composition.

1 8. The method of claim 7, wherein:

2 the at least one oligomer is present in an amount of about 12% of the  
3 weight of the electroluminescent composition;

4 the acrylate monomer is present in an amount of about 8% of the  
5 weight of the electroluminescent composition;

6 the photoinitiator is present in an amount of about 1% of the weight  
7 of the electroluminescent composition; and

8 the phosphor is present in an amount of about 75% of the weight of  
9 the electroluminescent composition;

10 an adhesion promoter in an amount of about 3% of the weight of the  
11 composition; and

12 a flow promoting agent in an amount of 1% of the weight of the  
13 electroluminescent composition.

1 9. The method of claim 3, wherein the method of applying the  
2 electroluminescent composition is spraying.

1 10. The method of claim 3, wherein the method of applying the  
2 electroluminescent composition is screen-printing.

1 11. The method of claim 3, wherein the method of applying the  
2 electroluminescent composition is dipping.

1 12. The method of claim 3, wherein the method of applying the  
2 electroluminescent composition is brushing.

1 13. The method of claim 3, wherein the method of applying the  
2 electroluminescent composition is the flexographic method.

1 14. The method of claim 3, wherein the aliphatic acrylated  
2 oligomer in the mixture is selected from the group consisting of:

3 a) aliphatic urethane diacrylate diluted 10% by weight with 1,6-  
4 hexanediol diacrylate;

5 b) aliphatic urethane triacrylate diluted 15% by weight with 1,6-  
6 hexanediol diacrylate);

7 c) aliphatic urethane diacrylate blended with 20% by weight  
8 tripropylene glycol diacrylate;

9 d) aliphatic urethane diacrylate blended with 25% by weight  
10 ethoxylated trimethylol propane triacrylate;

11 e) aliphatic urethane diacrylate blended with 19% by weight 2(2-  
12 ethoxyethoxy)ethyl acrylate;

13 f) aliphatic urethane diacrylate blended with 20% by weight  
14 tripropylene glycol diacrylate;

15 g) aliphatic urethane diacrylate blended with 20% by weight  
16 tripropylene glycol diacrylate;

17 h) aliphatic urethane diacrylate blended with 25% by weight  
18 tripropylene glycol diacrylate;

19 i) aliphatic urethane diacrylate; and

20 j) mixtures thereof.

1 15. The method of claim 3, wherein the acrylate monomer in the  
2 mixture is selected from the group consisting of acrylate, methacrylate, and  
3 mixtures thereof.

1 16. The method of claim 3, wherein the photoinitiator is selected  
2 from the group consisting of:

3 1-hydroxycyclohexyl phenyl ketone;

4 2-methyl-1-[4-(methylthio)phenyl]-2-morpholino propan-1-;

5 the combination of 50% 1-hydroxy cyclohexyl phenyl ketone and  
6 50% benzophenone;

7 2,2-dimethoxy-1,2-diphenylethan-1-one;

8 the combination of 25% bis(2,6-dimethoxybenzoyl-2,4-, 4-trimethyl  
9 pentyl phosphine oxide and 75% 2-hydroxy-2-methyl-1-phenyl-propan-1-one;

10                   2-hydroxy-2-methyl-1-phenyl-1-propane;  
 11                   the combination of 50% 2,4,6-trimethylbenzoyldiphenyl-phosphine  
 12   oxide and 50% 2-hydroxy 2-methyl-1-phenyl-propan-1-one;  
 13                   mixed triaryl sulfonium hexafluoroantimonate salts, mixed triaryl  
 14   sulfonium hexafluorophosphate salts; and  
 15                   mixtures thereof.

1                   17.    The method of claim 2, wherein the first conductive layer is  
 2   an opaque conductive layer and the second conductive layer is a transparent  
 3   conductive layer.

1                   18.    The method of claim 2, wherein the first conductive layer is  
 2   a transparent conductive layer and the second conductive layer is an opaque  
 3   conductive layer.

1                   19.    The method of claim 2, wherein the first conductive layer is  
 2   a transparent conductive layer and the second conductive layer is a transparent  
 3   conductive layer.

1                   20.    The method of claim 2 wherein the first conductive layer or  
 2   the second conductive layer is made by the process comprising:

3                   a)    applying an opaque conductive composition wherein the  
 4   opaque conductive composition is capable of being cured into the transparent  
 5   conductive layer when irradiated with UV light; and

6                   b)    curing the opaque conductive composition with UV light for  
 7   a sufficient time to form the first conductive layer.

1                   21.    The method of claim 20, wherein the opaque conductive  
 2   composition comprises comprising:

3                   a photocurable organic mixture;

4 a photoinitiator;  
5 silver powder; and  
6 silver flakes.

1 22. The method of claim 21, wherein the photocurable organic  
2 mixture comprises:  
3 an aliphatic acrylated urethane oligomer;  
4 an acrylated epoxy oligomer; and  
5 an isobornyl acrylate monomer.

1 23. The method of claim 22, wherein the aliphatic acrylated  
2 urethane oligomer is present in an amount of about 3% to 8% of the silver  
3 composition.

1 24. The method of claim 22, wherein the aliphatic acrylated  
2 urethane oligomer is present in an amount of about 8% of the silver composition.

1 25. The method of claim 22, wherein the acrylated epoxy  
2 oligomer is present in an amount of about 2% to 4% of the silver composition.

1 26. The method of claim 22, wherein the acrylated epoxy  
2 oligomer is present in an amount of about 3% of the silver composition.

1 27. The method of claim 22, wherein the isobornyl acrylate  
2 monomer is present in an amount of about 4% to 8% of the silver composition.

1 28. The method of claim 22, wherein the isobornyl acrylate  
2 monomer is present in an amount of about 5% of the silver composition.

1                   29.     The method of claim 22, wherein the silver powder is present  
2     in an amount of about 50% to 60% of the silver composition.

1                   30.     The method of claim 22, wherein the silver powder is present  
2     in an amount of about 52% of the silver composition.

1                   31.     The method of claim 22, wherein the silver flake is present  
2     in an amount of about 25% to 35% of the silver composition.

1                   32.     The method of claim 22, wherein the silver flake is present  
2     in an amount of about 30% of the silver composition.

1                   33.     The method of claim 22, wherein the photoinitiator is present  
2     in an amount of about 3% to 6% of the silver composition.

1                   34.     The method of claim 22, wherein the photoinitiator is  
2     present in an amount of about 5% of the silver composition.

1                   35.     The method of claim 22, wherein the photocurable organic  
2     mixture further comprises a flow promoting agent.

1                   36.     The method of claim 35, wherein the flow agent is present  
2     in an amount of about 0.1% to 2% of the silver composition.

1                   37.     The method of claim 35, wherein the flow agent is present  
2     in an amount of about 1% of the silver composition.

1                   38.     The method of claim 22, further comprising an adhesion  
2     promoter.

1                   39.    The method of claim 22, wherein the photocurable organic  
2 mixture comprises:  
3                   an acrylated epoxy oligomer;  
4                   an isobornyl acrylate monomer; and  
5                   a flow promoting agent.

1                   40.    The method of claim 2, wherein when the light-producing  
2 layer includes a dielectric layer, the dielectric layer is made by the method  
3 comprising:  
4                   a)     applying a dielectric composition wherein the dielectric  
5 composition is capable of being cured into the dielectric layer when irradiated with  
6 UV light; and  
7                   b)     curing the dielectric composition with UV light for a  
8 sufficient time to form the dielectric layer.

1                   41.    The method of claim 40, wherein the dielectric composition  
2 comprises:  
3                   a photocurable organic mixture;  
4                   dielectric material; and  
5                   a photoinitiator.

1                   42.    The method of claim 41, wherein the photocurable mixture  
2 comprises:  
3                   at least one oligomer is selected from the group consisting of an  
4 acrylated urethane oligomer, an acrylic oligomer, an epoxy oligomer, a polyester  
5 oligomer, and mixture thereof; and  
6                   an isobornyl acrylate monomer.

1                   43.    The method of claim 41, wherein the dielectric material is a  
2 nonconductive metal oxide or a mixture of nonconductive metal oxides.

1                   44.     The method of claim 41, wherein the dielectric material is  
2     selected from the group consisting of titanium oxide, barium titanate, zirconium  
3     oxide, and mixtures thereof.

1                   45.     The method of claim 41, wherein the photocurable mixture  
2     further comprises a flow promoting agent.

1                   46.     The method of claim 45, wherein the photocurable mixture  
2     further comprises an adhesion promoter.

1                   47.     The method of claim 46, wherein the at least one oligomer is  
2     present in an amount of about 10% to 40% of the total weight of the dielectric  
3     composition;

4                   the isobornyl acrylate monomer is present in an amount of about 5%  
5     to 30% of the total weight of the dielectric composition;

6                   the dielectric material is present in an amount of about 30% to 80%  
7     of the total weight of the dielectric composition;

8                   the photoinitiator is present in an amount of about 1% to 12% of the  
9     total weight of the dielectric composition;

10                  the flow promoting agent is present in an amount of about 0.5% to  
11     10% of the total weight of the dielectric composition; and

12                  the adhesion promoter is present in an amount of about 1% to 10%  
13     of the total weight of the dielectric composition.

1                   48.     The method of claim 2, wherein the first conductive layer or  
2     the second conductive layer or both the first conductive layer and second conductive  
3     layer are made by the process comprising:

- 4                   a)     applying a transparent conductive composition wherein the  
5 transparent conductive composition is capable of being cured into the conductive  
6 layer when irradiated with UV light; and  
7                   b)     curing the transparent conductive composition with UV light  
8 for a sufficient time to form the second conductive layer.

1                   49.     The method of claim 48, wherein the transparent conductive  
2 composition comprises:  
3                   a photocurable organic mixture;  
4                   a conductive powder; and  
5                   a photoinitiator.

1                   50.     The method of claim 49, wherein the photocurable organic  
2 mixture comprises:  
3                   at least one aliphatic acrylated oligomer;  
4                   an acrylated epoxy oligomer; and  
5                   an isobornyl acrylate monomer.

1                   51.     The method of claim 50, wherein the photocurable organic  
2 mixture further comprising a flow promoting agent.

1                   52.     The method of claim 51 wherein the acrylated aliphatic  
2 oligomer mixture is about 10 % to 40 % of the weight of the transparent conductive  
3 composition;  
4                   the acrylated epoxy oligomer is about 3 % to 11 % of the weight of  
5 the transparent conductive composition;  
6                   the isobornyl acrylate monomer is about 10 % to 40 % of the weight  
7 of the transparent conductive composition;  
8                   the photoinitiator is about 2 % to 10 % of the weight of the metallic  
9 composition;

10 the flow promoting agent is present in an amount of about 0.1 % to  
11 8 % of the weight of the transparent conductive composition; and  
12 the conductive powder is present in an amount of about 20 % to 50%  
13 of the weight of the transparent conductive composition.

1 53. The method of claim 52, wherein the acrylated aliphatic  
2 oligomer mixture is about 20 % to 30 % of the weight of the transparent conductive  
3 composition;  
4 the acrylated epoxy oligomer is about 5 % to 9 % of the weight of  
5 the transparent conductive composition;  
6 the isobornyl acrylate monomer is about 20 % to 35 % of the weight  
7 of the transparent conductive composition;  
8 the photoinitiator is about 4 % to 6 % of the weight of the metallic  
9 composition;  
10 the flow promoting agent is present in an amount of about 3 % to 5  
11 % of the weight of the transparent conductive composition; and  
12 the conductive powder is present in an amount of about 30 % to 40%  
13 of the weight of the transparent conductive composition.

1 54. The method of claim 53 wherein the acrylated aliphatic  
2 oligomer mixture is about 27 % of the weight of the transparent conductive  
3 composition;  
4 the acrylated epoxy oligomer is about 7 % of the weight of the  
5 transparent conductive composition;  
6 the isobornyl acrylate monomer is about 28 % of the weight of the  
7 transparent conductive composition;  
8 the photoinitiator is about 5 % of the weight of the metallic  
9 composition;  
10 the flow promoting agent is present in an amount of about 3.5 % of  
11 the weight of the transparent conductive composition; and

12 the conductive powder is present in an amount of about 33 % of the  
13 weight of the transparent conductive composition.

1 55. The method of claim 47, wherein the method of applying the  
2 transparent conductive composition is spraying.

1 56. The method of claim 47, wherein the method of applying the  
2 transparent conductive composition is screen printing.

1 57. The method of claim 47, wherein the method of applying the  
2 transparent conductive is dipping.

1 58. The method of claim 47, wherein the method of applying the  
2 transparent conductive is brushing.

1 59. The method of claim 47, wherein the method of applying the  
2 transparent conductive composition is by the flexographic method.

1 60. The method of claim 50, wherein the isobornyl acrylate  
2 monomer is selected from the group consisting of isobornyl acrylate, isobornyl  
3 methacrylate, and mixtures thereof.

1 61. The method of claim 50, wherein the photoinitiator is  
2 selected from the group consisting of:  
3 1-hydroxycyclohexyl phenyl ketone;  
4 2-methyl-1-[4-(methylthio)phenyl]-2-morpholino propan-1-;  
5 the combination of 50% 1-hydroxy cyclohexyl phenyl ketone and  
6 50% benzophenone;  
7 2,2-dimethoxy-1,2-diphenylethan-1-one;

8                   the combination of 25% bis(2,6-dimethoxybenzoyl-2,4-, 4-trimethyl  
9                   pentyl phosphine oxide and 75% 2-hydroxy-2-methyl-1-phenyl-propan-1-one;  
10                   2-hydroxy-2-methyl-1-phenyl-1-propane;  
11                   the combination of 50% 2,4,6-trimethylbenzoyldiphenyl-phosphine  
12                   oxide and 50% 2-hydroxy 2-methyl-1-phenyl-propan-1-one;  
13                   mixed triaryl sulfonium hexafluoroantimonate salts, mixed triaryl  
14                   sulfonium hexafluorophosphate salts; and  
15                   mixtures thereof.

1                   62.    The method of claim 50, wherein the acrylated epoxy  
2                   oligomer is selected from the group consisting of:  
3                   novolac epoxy acrylate diluted 20 % by weight with tripropylene  
4                   glycol diacrylate;  
5                   difunctional bisphenol based epoxy acrylate; and  
6                   mixtures thereof.

1                   63.    The method of claim 2, further comprising:  
2                   a)     applying a clear-coat composition to the electroluminescent  
3                   active layer wherein the clear-coat composition is capable of being cured into the  
4                   dielectric layer when irradiated with UV light; and  
5                   b)     curing the clear-coat composition applied to the  
6                   electroluminescent layer with UV light for a sufficient time to form the clear-coat.

1                   64.    A method for forming an electroluminescent lamp on a  
2                   substrate, the method comprises:  
3                   a)     applying an opaque conductive composition to a substrate  
4                   wherein the opaque conductive composition has the characteristic of being curable  
5                   into an conductive layer when irradiated with UV light;;

6                   b)     curing the opaque conductive composition applied to the  
7 substrate with UV light for a sufficient time to form the opaque conductive layer  
8 on the substrate;

9                   c)     applying an electroluminescent composition to the opaque  
10 conductive layer wherein the electroluminescent composition has the characteristic  
11 of being curable into an electroluminescent active layer when irradiated with UV  
12 light;

13                  d)     curing the electroluminescent composition applied to the  
14 opaque conductive layer with UV light for a sufficient time to form the  
15 electroluminescent active layer;

16                  f)     applying a dielectric composition to the electroluminescent  
17 active layer wherein the dielectric composition has the characteristic of being  
18 curable into a dielectric layer when irradiated with UV light;

19                  g)     curing the dielectric composition applied to the substrate with  
20 UV light for a sufficient time to form the dielectric layer;

21                  h)     applying a transparent conductive composition to the dielectric  
22 layer wherein the transparent conductive composition is capable of being cured into  
23 a transparent conductive layer when irradiated with UV light; and

24                  i)     curing the transparent conductive composition applied to the  
25 dielectric layer with UV light for a sufficient time to form the transparent  
26 conductive layer.

1                   65.    A UV curable dielectric composition comprising:  
2                   a photocurable organic mixture;  
3                   dielectric material; and  
4                   a photoinitiator.

1                   66.    The dielectric composition of claim 65, wherein the  
2 photocurable mixture comprises:

3 at least one oligomer is selected from the group consisting of an  
4 acrylated urethane oligomer, an acrylic oligomer, an epoxy oligomer, a polyester  
5 oligomer, and mixture thereof; and  
6 an isobornyl acrylate monomer.

1 67. The dielectric composition of claim 65, wherein the dielectric  
2 material is a nonconductive metal oxide.

1 68. The dielectric composition of claim 65, wherein the dielectric  
2 material is selected from the group consisting of titanium oxide, barium titanate,  
3 zirconium oxide, and mixtures thereof.

1 69. The dielectric composition of claim 65, wherein the  
2 photocurable mixture further comprises a flow promoting agent.

1 70. The dielectric composition of claim 69, wherein the  
2 photocurable mixture further comprises an adhesion promoter.

1 71. The dielectric composition of claim 70, wherein:  
2 the acrylated aliphatic urethane oligomer is present in an amount of  
3 about 10% to 40% of the total weight of the dielectric composition;  
4 the isobornyl acrylate monomer is present in an amount of about 5%  
5 to 30% of the total weight of the dielectric composition;  
6 the dielectric material is present in an amount of about 30% to 80%  
7 of the total weight of the dielectric composition;  
8 the photoinitiator is present in an amount of about 1% to 12% of the  
9 total weight of the dielectric composition;  
10 the flow promoting agent is present in an amount of about 0.5% to  
11 10% of the total weight of the dielectric composition; and

- 12                    the adhesion promoter is present in an amount of about 1% to 10%
- 13    of the total weight of the dielectric composition.

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